



**DMN2400UV** 

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
20V	0.48Ω @ V <sub>GS</sub> = 5V	1.33A
200	0.7Ω @ V <sub>GS</sub> = 2.5V	1.2A

# Description

This new generation MOSFET has been designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### Applications

- **Power Management Functions**
- Battery Operated Systems and Solid-State Relays
- Load Switch

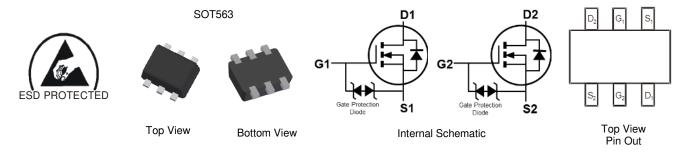
### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

### Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.
- https://www.diodes.com/guality/product-definitions/

# **Mechanical Data**

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.003 grams (Approximate)



# Ordering Information (Note 4)

	Part Number	Case	Packaging			
	DMN2400UV-7	SOT563	3,000/Tape & Reel			
	DMN2400UV-13	SOT563	10,000/Tape & Reel			
Notes:	Notes: 1. No purposely added lead, Fully EU Directive 2002/95/EC (BoHS), 2011/65/EU (BoHS 2) & 2015/863/EU (BoHS 3) compliant.					

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**

24N YM	NAB YI

24N and NAB = Marking Code YM = Date Code Marking Y = Year (ex: G = 2019)

M = Month (ex: 9 = September)

#### Date Code Key

Duie Obue Rey															
Year	200	9	~	~ 2019		2019 2020		2021		2022		2023			
Code	W		~		G		G H		4	I		J		К	
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec			
Code	1	2	3	4	5	6	7	8	9	0	N	D			



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characterist	ic		Symbol	Value	Unit
Drain-Source Voltage			V <sub>DSS</sub>	20	V
Gate-Source Voltage		V <sub>GSS</sub>	±12	V	
Continuous Drain Current (Note 5)	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +85°C	ID	1.33 0.84	А
Pulsed Drain Current			I <sub>DM</sub>	3	А

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	530	mW
Thermal Resistance, Junction to Ambient	R <sub>0JA</sub>	233.8	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

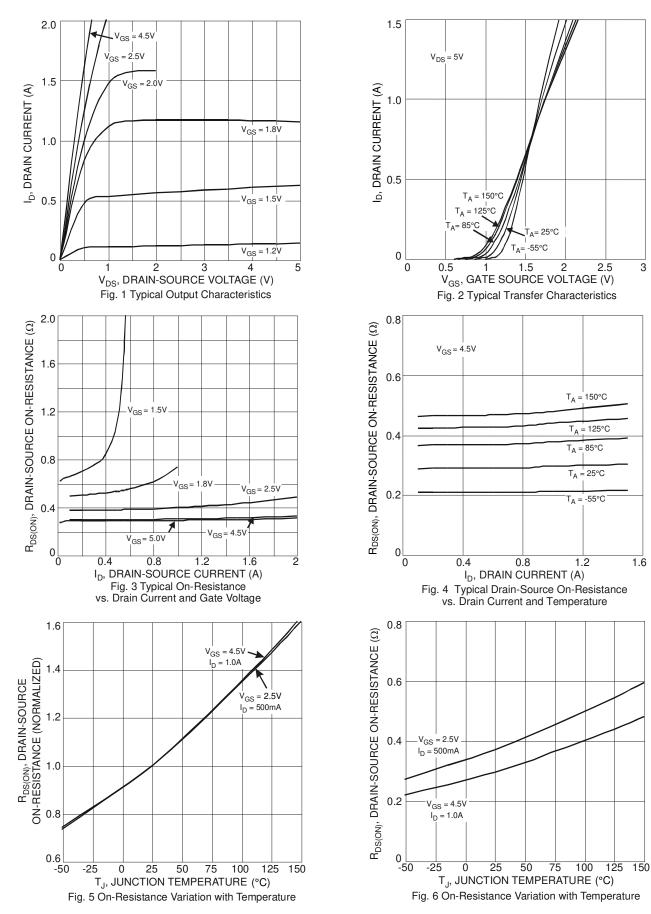
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)						÷	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_		V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current TJ = +25°C	I <sub>DSS</sub>		_	100	nA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	1		—	±1.0	μA	$V_{GS} = \pm 4.5V, V_{DS} = 0V$	
Gale-Source Leakage	IGSS		—	±50		$V_{GS} = \pm 10V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.5		0.9	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
			0.3	0.48		$V_{GS} = 5.0V, I_D = 200mA$	
		_	0.35	0.5		$V_{GS} = 4.5V, I_D = 600mA$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	-	0.45	0.7	Ω	$V_{GS} = 2.5V, I_D = 500mA$	
			0.55	0.9		$V_{GS} = 1.8V, I_D = 350mA$	
		-	0.65	1.5		$V_{GS} = 1.5V, I_D = 50mA$	
Forward Transfer Admittance	Y <sub>fs</sub>	_	1.4	_	S	$V_{DS} = 10V, I_D = 400mA$	
Diode Forward Voltage (Note 6)	V <sub>SD</sub>		0.7	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 150mA, f = 1.0MHz	
DYNAMIC CHARACTERISTICS (Note 7)			1				
Input Capacitance	Ciss	_	36.0		pF		
Output Capacitance	C <sub>oss</sub>	_	5.7	—	pF	$-V_{DS} = 16V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	4.2	—	pF		
Gate Resistance	Rg	_	68	—	Ω	$V_{DS} = 0V, V_{GS} = 0V$	
Total Gate Charge	Qq	_	0.5	—	nC		
Gate-Source Charge	Q <sub>gs</sub>	—	0.07	—	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$	
Gate-Drain Charge	Q <sub>gd</sub>	_	0.1		nC	– I <sub>D</sub> =250mA	
Turn-On Delay Time	t <sub>D(ON)</sub>		4.06		ns		
Turn-On Rise Time	t <sub>R</sub>		7.28		ns	$V_{DD} = 10V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>		13.74	—	ns	$R_L = 47\Omega, R_G = 10\Omega,$	
Turn-Off Fall Time	tF		10.54		ns	$-I_D = 200 \text{mA}$	

5. Device soldered onto FR-4 PCB, minimum recommended soldering pad dimensions (25.4mm x 25.4mm x1.6mm, 2oz Cu pad: 0.18mm<sup>2</sup> x 6). Notes: Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.

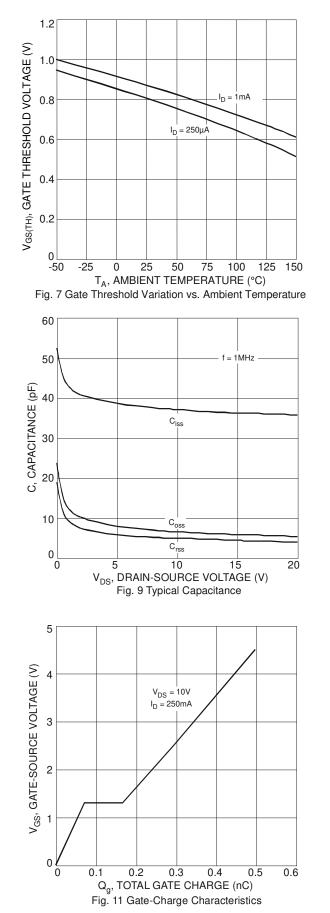


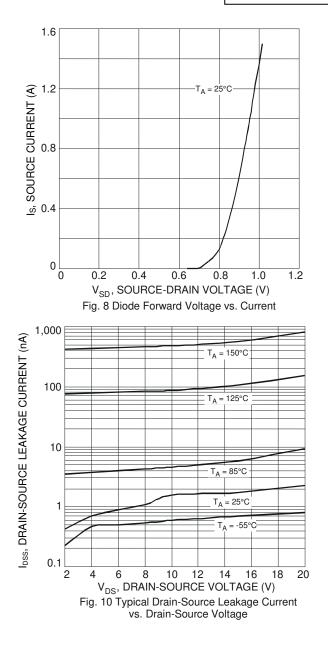
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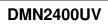




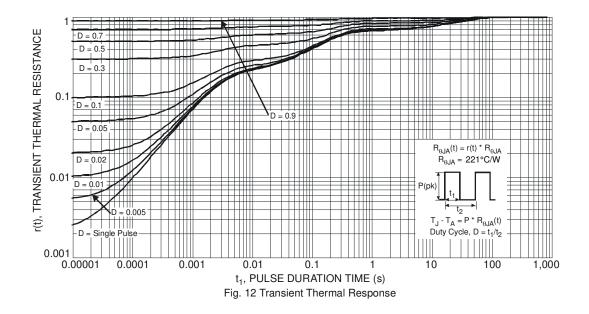
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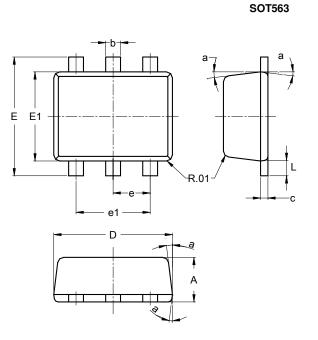






# **Package Outline Dimensions**

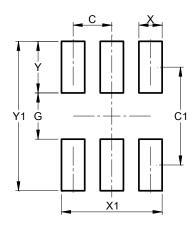
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT563							
Dim	Min	Max	Тур				
Α	0.55	0.60	0.60				
b	0.15	0.30	0.20				
С	0.10	0.18	0.11				
D	1.50	1.70	1.60				
Е	1.55	1.70	1.60				
E1	1.10	1.25	1.20				
е			0.50				
e1	0.90	1.10	1.00				
L	0.10	0.30	0.20				
а	8°	9°	7°				
All	All Dimensions in mm						

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT563

Dimensions	Value (in mm)
С	0.500
C1	1.270
G	0.600
Х	0.300
X1	1.300
Y	0.670
Y1	1.940



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